

Low Voltage 1.2V/1.8V/2.5V 2:6 MUX with Crosspoint Capability 5GHz/6.4Gbps

General Description

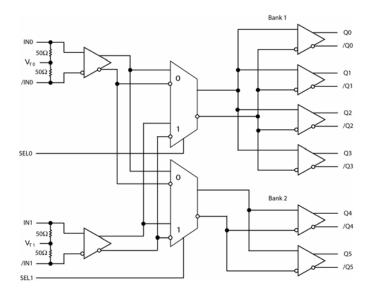
The SY56034AR is a fully differential, low voltage 1.2V/1.8V/2.5V CML 2:6 (2+4) MUX with crosspoint capability. The SY56034AR can process clock signals as fast as 5GHz or data patterns up to 6.4Gbps.

The differential input includes Micrel's unique, 3-pin input termination architecture that interfaces to LVPECL, LVDS or CML differential signals as small as 100mV ($200mV_{pp}$) without any level-shifting or termination resistor networks in the signal path. For AC-coupled input interface applications, an internal voltage reference is provided to bias the V_T pin. The outputs are 400mV CML, with extremely fast rise/fall times guaranteed to be less than 80ps.

The SY56034AR operates from a 2.5V \pm 5% core supply and a 1.2V/1.8V/2.5V \pm 5% output supply and is guaranteed over the full industrial temperature range (-40°C to +85°C). The SY56034AR is part of Micrel's high-speed, Precision Edge[®] product line.

Datasheets and support documentation can be found on Micrel's web site at: <u>www.micrel.com</u>.

Functional Block Diagram





Precision Edge®

Features

- 1.2V/1.8V/2.5V CML 2:6 (2+4) MUX with Crosspoint Capability
- Guaranteed AC performance over temperature and voltage:
 - DC-to- > 6.4Gbps throughput
 - <300ps propagation delay (IN-to-Q)
 - <25ps Output skew
 - <80ps rise/fall times
- Ultra-low jitter design
 - <1ps_{RMS} cycle-to-cycle jitter
 - <10ps_{PP} total jitter
 - <1ps_{RMS} random jitter
 - <10ps_{PP} deterministic jitter
- High-speed CML outputs
- 2.5V ±5% , 1.2V/1.8V/2.5V ±5% power supply operation
- Industrial temperature range: –40°C to +85°C
- Available in 32-pin MLF[®] package

Applications

- Data Distribution: OC-48, OC-48+FEC
- SONET clock and data distribution
- Fibre Channel clock and data distribution
- Gigabit Ethernet clock and data distribution

Markets

- Storage
- ATE
- Test and measurement
- Enterprise networking equipment
- High-end servers
- Access
- Metro area network equipment

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Ordering Information⁽¹⁾

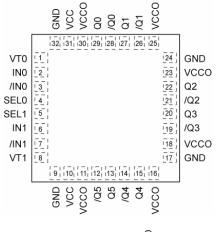
Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY56034ARMG	MLF-32	Industrial	56034AR with Pb-Free bar-line indicator	NiPdAu Pb-Free
SY56034ARMGTR ⁽²⁾	MLF-32	Industrial	56034AR with Pb-Free bar-line indicator	NiPdAu Pb-Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^{\circ}C$, DC Electricals only.

2. Tape and Reel.

Pin Configuration



32-Pin MLF[®] (MLF[®]-32)

Truth Table

SEL0	SEL1	Bank1	Bank2
L	L	IN0	IN0
L	Н	IN0	IN1
Н	L	IN1	IN0
Н	Н	IN1	IN1

Pin Description

Pin Number	Pin Name	Pin Function
2,3	IN0, /IN0	Differential Inputs: These input pairs are the differential signal inputs to the device.
6,7	IN1,/IN1	They accept differential signals as small as 100mV (200mV _{PP}). Each input pin internally terminates with 50 Ω to the VT pin.
1	VT0	Input Termination Center-Tap: Each side of the differential input pair terminates to a
8	VT1	VT pin. This pin provides a center-tap to a termination network for maximum interface flexibility. An internal high impedance resistor divider biases VT to allow input AC-coupling. For AC-coupling, bypass VT with a 0.1µF low ESR capacitor to VCC. See "Interface Applications" subsection and Figure 2a.
4	SEL0	These single-ended TTL/CMOS-compatible inputs select the inputs to the
5	SEL1	crosspoint switch. Note that each of these inputs is internally connected to a $25k\Omega$ pull-up resistor and will default to a logic HIGH state if left open.
10, 31	VCC	Positive Power Supply: Bypass with $0.1\mu F//0.01\mu F$ low ESR capacitors as close to the V _{CC} pin as possible. Supplies input and core circuitry.
11,16,18,	VCCO	Output Supply: Bypass with $0.1\mu F//0.01\mu F$ low ESR capacitors as close to the V _{CCO}
23,25,30		pins as possible. Supplies the output buffer.
9,17,24,32	GND, Exposed pad	Ground: Exposed pad must be connected to a ground plane that is the same potential as the ground pin.
29,28	Q0, /Q0	CML Differential Output Pairs: Differential buffered copy of the selected input signal.
27,26	Q1, /Q1	The output swing is typically 390mV. See "Interface Applications" subsection for termination information. Output pairs Q0 to Q3 belong to Bank 1. Q4 and Q5 belong
22,21	Q2, /Q2	to Bank 2.
20,19	Q3, /Q3	
15,14	Q4, /Q4	
13,12	Q5, /Q5	

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_CC) $-0.5V$ to $+3.0V$ Supply Voltage (V_CCO) $-0.5V$ to $+2.7V$
V _{CC} - V _{CCO}
V _{CCO} - V _{CC}
Input Voltage (V_{IN})–0.5V to V_{CC} + 0.5V
CML Output Voltage (V _{OUT})0.6V to V _{CCO} +0.5V
Current (V _T)
Source or sink current on VT pin±100mA
Input Current
Source or sink current on (IN, /IN)±50mA
Maximum operating Junction Temperature 125°C
Lead Temperature (soldering, 20sec.)
Storage Temperature (T _s)–65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage (V _{CC})	
Ambient Temperature (T _A) Package Thermal Resistance ⁽³⁾	
MLF [®]	
Still-air (θ_{JA})	50°C/W
Junction-to-board (ψ_{JB})	20°C/W

DC Electrical Characteristics⁽⁴⁾

 $T_A = -40^{\circ}C$ to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{CC}	Power Supply Voltage Range	V _{cc}	2.375	2.5	2.625	V
		V _{cco}	1.14	1.2	1.26	V
		V _{cco}	1.7	1.8	1.9	V
		V _{cco}	2.375	2.5	2.625	V
I _{CC}	Power Supply Current	Max. V _{CC}		100	140	mA
Icco	Power Supply Current	No Load. Max V _{CCO}		96	126	mA
R _{IN}	Input Resistance (IN-to-V _T , /IN-to-V _T)		45	50	55	Ω
Rdiff_in	Differential Input Resistance (IN-to-/IN)		90	100	110	Ω
VIH	Input HIGH Voltage (IN, /IN)	IN, /IN	1.2		Vcc	V
VIL	Input LOW Voltage (IN, /IN)	V_{IL} with V_{IH} = 1.2V	0.2		V _{IH} –0.1	V
V _{IH}	Input HIGH Voltage (IN, /IN)	IN, /IN	1.14		V _{cc}	V
V _{IL}	Input LOW Voltage (IN, /IN)	V_{IL} with V_{IH} = 1.14V (1.2V-5%)	0.66		V _{IH} –0.1	V
V _{IN}	Input Voltage Swing (IN, /IN)	see Figure 3a	0.1		1.0	V
V_{DIFF_IN}	Differential Input Voltage Swing (IN - /IN)	see Figure 3b	0.2		2.0	V
V _{T_IN}	Voltage from Input to V_T				1.28	V

Notes:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

Package thermal resistance assumes exposed pad is soldered (or equivalent) to the device's most negative potential on the PCB. ψ_{JB} and θ_{JA} values are determined for a 4-layer board in still-air number, unless otherwise stated. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

CML Outputs DC Electrical Characteristics⁽⁵⁾

 V_{CCO} = 1.14V to 1.26V, R_L = 50 Ω to V_{CCO} ,

 V_{CCO} = 1.7V to 1.9V, 2.375V to 2.625V, R_L = 50 Ω to V_{CCO} or 100 Ω across the outputs.

 V_{CC} = 2.375V to 2.625V. T_A = -40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{OH}	Output HIGH Voltage	R_L = 50 Ω to V_{CCO}	V _{CCO} -0.020	V _{CCO} -0.010	Vcco	V
V _{OUT}	Output Voltage Swing	See Figure 3a	300	390	475	mV
V _{DIFF_OUT}	Differential Output Voltage Swing	See Figure 3b	600	780	950	mV
Rout	Output Source Impedance		45	50	55	Ω

LVTTL/CMOS DC Electrical Characteristics⁽⁵⁾

 V_{CC} = 2.5V ±5%. T_A = –40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
VIH	Input HIGH Voltage		2.0		V _{CC}	V
VIL	Input LOW Voltage				0.8	V
I _{IH}	Input HIGH Current		-125		30	μA
I _{IL}	Input LOW Current		-300			μA

Note:

5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

AC Electrical Characteristics

 V_{CCO} = 1.14V to 1.26V, R_L = 50 Ω to V_{CCO_L}

 V_{CCO} = 1.7V to 1.9V, 2.375V to 2.625V, R_L = 50 Ω to V_{CCO} or 100 Ω across the outputs.

 V_{CC} = 2.375V to 2.625V. T_A = -40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
f _{MAX}	Maximum Frequency	NRZ Data	6.4			Gbps
		V _{OUT} > 200mV Cloo	ck 5			GHz
t _{PD}	Propagation Delay IN-to-Q	Figure 1	150	220	300	ps
	SEL-to-Q	Figure 1	100	200	300	ps
t _{Skew}	Input-to-Input Skew	Note 6		5	15	ps
	Output-to-Output skew	Note 7, All Outputs or Q0-Q3		7	25	ps
	Output-to-Output skew	Note 7, Q4-Q5		4	20	ps
	Part-to-Part Skew	Note 8			75	ps
t _{Jitter}	Data Random Jitter	Note 9			1	ps _{RMS}
	Deterministic Jitter	Note 10			10	ps _{PP}
	Clock Cycle-to-Cycle Jitter	Note 11			1	ps _{RMS}
	Total Jitter	Note 12			10	ps _{PP}
	Crosstalk Induced Jitter	Note 13			0.7	ps _{PP}
	(Adjacent Channel)					
t _R , t _F	Output Rise/Fall Times (20% to 80%)	At full output swing.	20	60	80	ps
	Duty Cycle	≤4GHz Differential I/O	47		53	%
	Duty Cycle	<5GHz Differential I/O	45		55	%

Notes:

6. Input-to-Input skew is the difference in time between both inputs, measured at the same output, for the same temperature, voltage and transition.

7. Output-to-Output skew is the difference in time between both outputs, receiving data from the same input, for the same temperature, voltage and transition.

8. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and no skew at the edges at the respective inputs.

9. Random jitter is measured with a K28.7 pattern, measured at $\leq f_{MAX}$.

10. Deterministic jitter is measured at 2.5Gbps with both K28.5 and 2²³–1 PRBS pattern.

11. Cycle-to-cycle jitter definition: the variation period between adjacent cycles over a random sample of adjacent cycle pairs. $t_{JITTER_CC} = T_n - T_{n+1}$, where T is the time between rising edges of the output signal.

Total jitter definition: with an ideal clock input frequency of ≤ f_{MAX} (device), no more than one output edge in 10¹² output edges will deviate by more than the specified peak-to-peak jitter value.

13. Crosstalk-induced jitter is defined as the added jitter that results from signals applied to the adjacent channel. It is measured at the output while applying a similar, differential clock frequency to both inputs that is asynchronous with respect to each other.

Interface Applications

For Input Interface Applications, see Figures 4a through 4f. For CML Output Termination, see Figures 5a through Figure 5d.

CML Output Termination with VCCO 1.2V

For VCCO of 1.2V, Figure 5a, terminate the output with 50Ω -to-1.2V, DC coupled, not 100Ω differentially across the outputs.

If AC-coupling is used, Figure 5d, terminate into 50Ω -to-1.2V before the coupling capacitor and then connect to a high value resistor to a reference voltage.

Do not AC couple with internally terminated receiver. For example, 50Ω ANY-IN input. AC-coupling will offset the output voltage by 200mV and this offset voltage will be too low for proper driver operation. Any unused output pair needs to be terminated when VCCO is 1.2V, do not leave floating.

CML Output Termination with VCCO 1.8V, 2.5V

For VCCO of 1.8V or 2.5V, Figure 5a and Figure 5b, terminate with either 50Ω -to-1.8V or 100Ω differentially across the outputs. AC- or DC-coupling is fine. See Figure 5c for AC-coupling.

Input AC-Coupling

The SY56034AR input can accept AC-coupling from any driver. Bypass VT with a 0.1μ F low ESR capacitor to VCC as shown in Figures 4c and 4d. VT has an internal high impedance resistor divider as shown in Figure 2a, to provide a bias voltage for AC-coupling.

Timing Diagrams

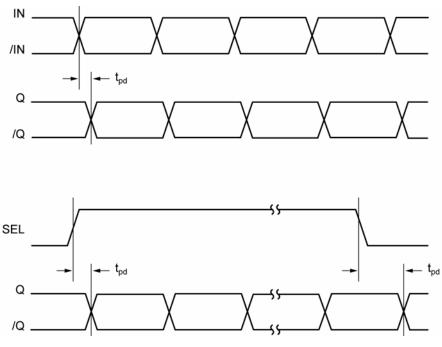
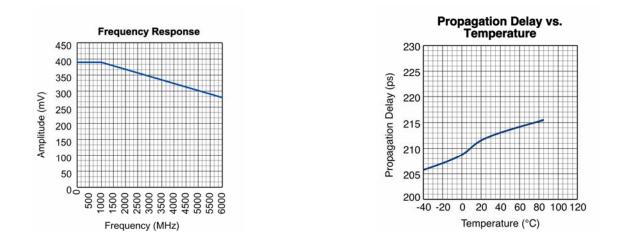


Figure 1. Propagation Delay

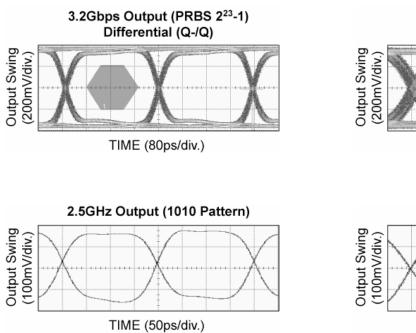
Typical Characteristics

 V_{CC} = 2.5V, V_{CCO} =1.2V, GND = 0V, V_{IN} = 100mV, R_L = 50 Ω to 1.2V, T_A = 25°C, unless otherwise stated.

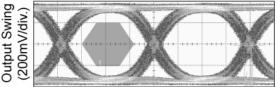


Functional Characteristics

 V_{CC} = 2.5V, V_{CCO} =1.2V, GND = 0V, V_{IN} = 400mV, R_L = 50 Ω to 1.2V, T_A = 25°C, unless otherwise stated.

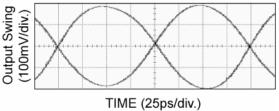


6.4Gbps Output (PRBS 2²³-1) Differential (Q-/Q)



TIME (40ps/div.)

5GHz Output (1010 Pattern)



Input and Output Stage

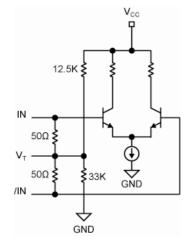


Figure 2a. Simplified Differential Input Buffer

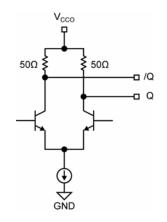


Figure 2b. Simplified CML Output Buffer

Single-Ended and Differential Swings



Figure 3a. Single-Ended Swing

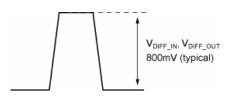


Figure 3b. Differential Swing

10

Input Interface Applications

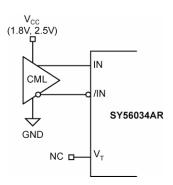


Figure 4a. CML Interface (DC-Coupled, 1.8V, 2.5V) Option: V_T may be connected to V_{CC}

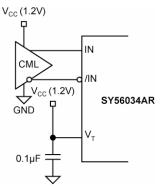


Figure 4b. CML Interface (DC-Coupled, 1.2V)

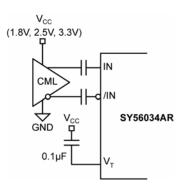


Figure 4c. CML Interface (AC-Coupled)

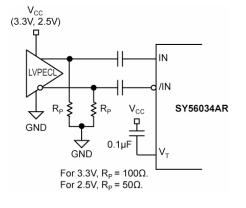


Figure 4d. LVPECL Interface (AC-Coupled)

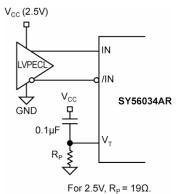


Figure 4e. LVPECL Interface (DC-Coupled)

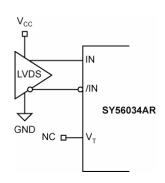
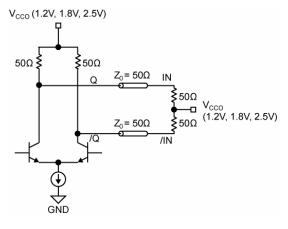
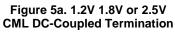
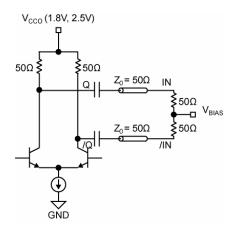


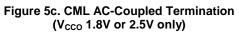
Figure 4f. LVDS Interface

CML Output Termination









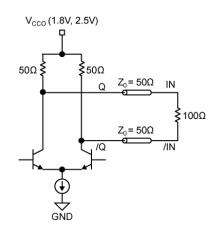


Figure 5b. 1.8V or 2.5V CML DC-Coupled Termination

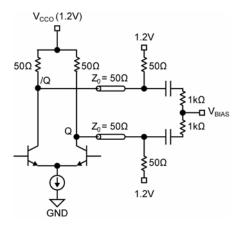
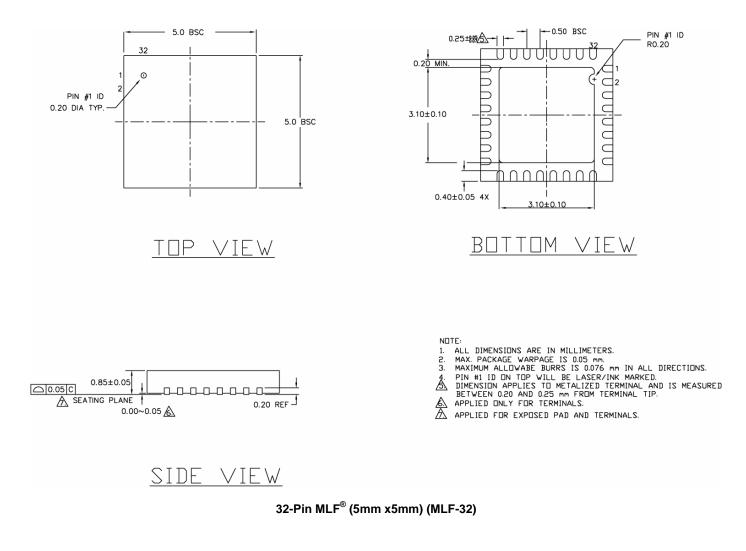


Figure 5d. CML AC-Coupled Termination (V_{CC0} 1.2V only)

Related Product and Support Documents

Part Number	Function	Datasheet Link
HBW Solutions	New Products and Termination Application Notes	http://www.micrel.com/page.do?page=/product- info/as/HBWsolutions.shtml

Package Information



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